

C0805C273G3GACTU

Aliases (C0805C273G3GAC7800) SMD Comm COG, Ceramic, 0.027 uF, 2%, 25 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0805, 0.7 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
	Capacitance	0.027 uF
	Measurement Condition	1 kHz 1.0Vrms
	Tolerance	2%
	Voltage DC	25 VDC
	Dielectric Withstanding Voltage	62.5 VDC
	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
1	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
	Dissipation Factor	0.1% 1 kHz 1.0Vrms
	Aging Rate	0% Loss/Decade Hour
	Insulation Resistance	37.037 GOhms

Dimensions		
Chip Size	0805	
L	2mm +/-0.2mm	
W	1.25mm +/-0.2mm	
т	1.1mm +/-0.10mm	
S	0.7mm MIN	
В	0.5mm +/-0.25mm	

Packaging Specifications T&R, 180mm, Plastic Tape Packaging Packaging Quantity

2500

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